

THE GRADUATE SCHOOL

Office of the Dean

TO:

Debasish (Deba) Dutta, Provost

FROM:

Mark J. T. Smith, Dean

DATE:

May 24, 2016

SUBJECT: Combined Bachelor of Science in Computer Engineering or Bachelor of Science in

Electrical Engineering with a Master of Science in Engineering from Purdue University

Fort Wayne

I am transmitting for your information, review, and approval, a proposal for a Combined Bachelor of Science in Computer Engineering or Bachelor of Science in Electrical Engineering with a Master of Science in Engineering from Purdue University Fort Wayne. This combined degree program will be offered by the Department of Electrical and Computer Engineering in the College of Engineering, Technology, and Computer Science.

The proposed program will keep both undergraduate and graduate programs vibrant and healthy, will meet the demand of skilled workforce in Northeast Indiana, and will have high graduation and retention rates by attracting high potential students. Northeast Indiana is home to more than 160 advanced manufacturing companies in areas including electronics, defense, automotive, and electric machines. There is a high demand for the industry to have a skilled workforce.

The Graduate School has reviewed the proposal for compliance with policies and procedures governing combined degree programs and verified that the proposed program meets those requirements. Students who graduate from this program will meet all the requirements for both degrees. Since these degrees are already recognized degrees, they do not require action by the Board of Trustees or by the Indiana Commission for Higher Education.

The Graduate School will review the combined degree in four years to assure that the enrollments are reasonable. If they are not significant, the combined degree offering will be discontinued.

Please let me know if you have any questions. Thanks for your consideration of this important innovation in graduate education.

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Copies: James Mohler, Candiss Vibbert, Carol Sternberger, Abdullah Eroglu

Enclosure: Proposal with signature page

MJTS/tlp